

Thank you for using the CS+ integrated development environment.

This document describes restrictions on and points for caution regarding the simulator.

Read this document before using the product.

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## Chapter 1. Target Devices

The simulator allows the simulation of instructions for the following RH850 CPU cores: RH850G4MH, RH850G3M, RH850G3MH, RH850G3K, and RH850G3KH.

The target devices the CS+ IDE supports are listed on the Web site.

Please see the URL below.

CS+ Product Page

<http://www.renesas.com/cs+>

## Chapter 2. User's Manuals

Please read the following user's manuals together with this document.

Manual Name	Document Number
CS+ V8.04.00 Integrated Development Environment User's Manual: RH850 Debug Tool	R20UT4693EJ0100
CS+ V8.04.00 Integrated Development Environment User's Manual: Message	R20UT4690EJ0100

## Chapter 3. Uninstallation

There are two ways to uninstall this product.

- Use the integrated uninstaller from Renesas (uninstalls all CS+ components)
- Use the Windows uninstaller (only uninstalls this product)

To use the Windows uninstaller, select [CS+ for CC] from [Apps & features] from [Settings] of Windows or [Programs and Features] of the control panel.

## Chapter 4. Changes

Changes from V5.01.00 to V5.02.00 of the instruction simulator for RH850 devices are improvements in simulator operation and are also applicable to the instruction simulator for RL78 devices. For details, refer to section 4.2, Additions and improvements to the debug tool, in the CS+ for CC V8.04.00 Release Note (R20UT4804EJ0100).

## Chapter 5. Points for Caution

This chapter describes points you will need to note when you are using the simulator.

For details, refer to section 2.3.3, [Simulator], in the CS+ V8.04.00 Integrated Development Environment User's Manual: RH850 Debug Tool.

### 5.1 CPU Operating Clock

The CPU clock operates at the frequency set up with the property "Main clock frequency [MHz]" of the simulator.

### 5.2 Access Latency

Since the latency of access to the various types of memory and peripheral modules is not considered, the execution times (numbers of cycles) will be different from those for the actual device.

Thus, the results of measuring the following items differ according to whether the instruction simulator or an actual device is in use.

- The results of measurement by the Run-Break timer
- The results of measurement of Timer Result events
- The [Pipeline] area of the Trace panel
- The [Time] area of the Trace panel
- Result of tracing when the trace target is selected as [All core] (timing between processor elements)
- Timestamps of the software trace data

### 5.3 Peripheral Functions

The simulator does not support simulation of the peripheral functions.

### 5.4 Controlling Booting up of Individual CPUs

Some RH850 MCUs have specific option bytes for selecting the boot mode for the CPUs and IO registers for selecting which CPUs should be booted up when the MCU is reset. The simulator, on the other hand, does not support such facilities and all CPUs are booted up when the MCU is reset.

## Chapter 6. Restriction

This chapter describes restriction on the use of the simulator.

### 6.1 Simulation of the HALT Instruction

[Affected device] RH850G4MH

[Details] Execution of the HALT instruction is not reflected in the results of tracing. However, the results of tracing in the processor elements for which the HALT instruction was not executed are not affected.

[Workaround] There is no workaround.

[Schedule for fixing the problem] We will fix this problem in the next and subsequent versions.

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## Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

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